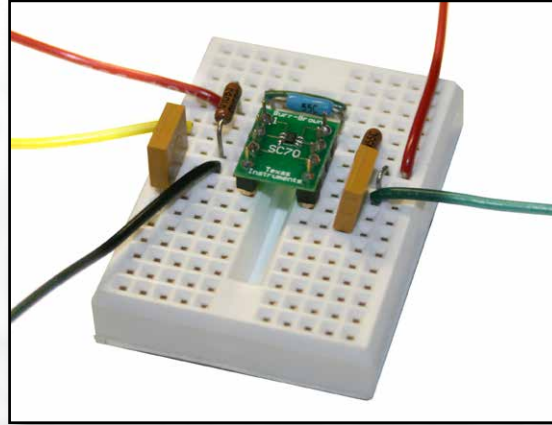


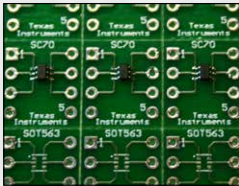
# DIP Adapter EVM

## Simplifies prototyping SMT ICs

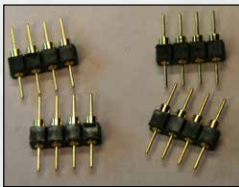
Supports SOIC-8 (U), TSSOP-8 (PW), MSOP-8 (DGK), SOT23-6 (DBV), SC70-6 (DCK) and SOT563-6 (DRL) packages



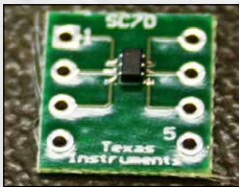
## Usage Instructions



Solder IC(s) to adapter pcb. Parts may be hand soldered or attached with IR or hot air reflow techniques.



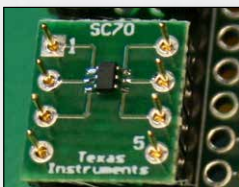
Use long nose pliers to snap terminal strips into 4 position lengths.



Gently flex panel at score lines to separate boards.



Insert terminal strips into a spare DIP socket to align pins.



Position board over pins and solder the connections. Carefully remove from DIP socket. Done!

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